

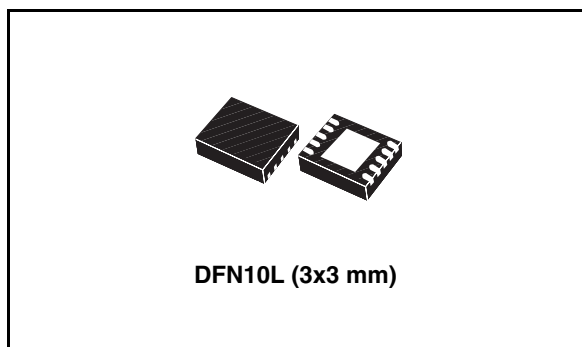
Power supply for PMOLED display panel

Features

- Synchronous step-up converter
- Input voltage range from 2.5 V to 5.5 V
- Maximum output current 120 mA
- Efficiency: 75 % at $I_O = 10 \text{ mA} - 30 \text{ mA}$; 85 % at $I_O = 30 \text{ mA} - 120 \text{ mA}$
- Switching at 1.2 MHz in typical application conditions
- Enable pin for shutdown mode
- True load disconnect
- Soft-start to limit inrush current
- UVLO protection
- Adjustable output voltage up to 20 V
- Low quiescent current: < 1 μA in shutdown mode
- Over-temperature protection
- Package: DFN10L 3x3 mm, 0.8 mm
- Operating junction temperature range: -40 °C to 125 °C

Applications

- Passive matrix OLED power supplies
- Mobile phones
- PDAs
- Camcorders
- Digital still cameras



Description

STOD1812 is a step-up converter designed to power passive matrix OLED (PMOLED) displays, providing the pre-charge and biasing voltage of the column matrix driver. STOD1812 uses a pulsed frequency modulation (PFM) control mode technique. The high switching frequency makes it possible to reduce the value and size of the external components. This device is particularly suitable for battery-operated applications, where overall system efficiency is the major concern.

Synchronous rectification has been integrated in the device in order to eliminate the external Schottky diode. An internal compensation net is also integrated, enabling the STOD1812 to provide excellent load transient performance in addition to good load regulation.

The output voltage is set using two external resistors. Over-temperature protection and under-voltage lockout (UVLO) functions are integrated in the device. An additional switch implements a true load disconnection feature which stops the current flowing from the input when the device is in shutdown mode. The EN pin turns off the device, reducing the quiescent current to 0.1 μA .

Table 1. Device summary

Order code	Package	Packaging
STOD1812PUR	DFN10L (3x3 mm)	3000 parts per reel

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1 Diagram

Figure 1. Internal block diagram

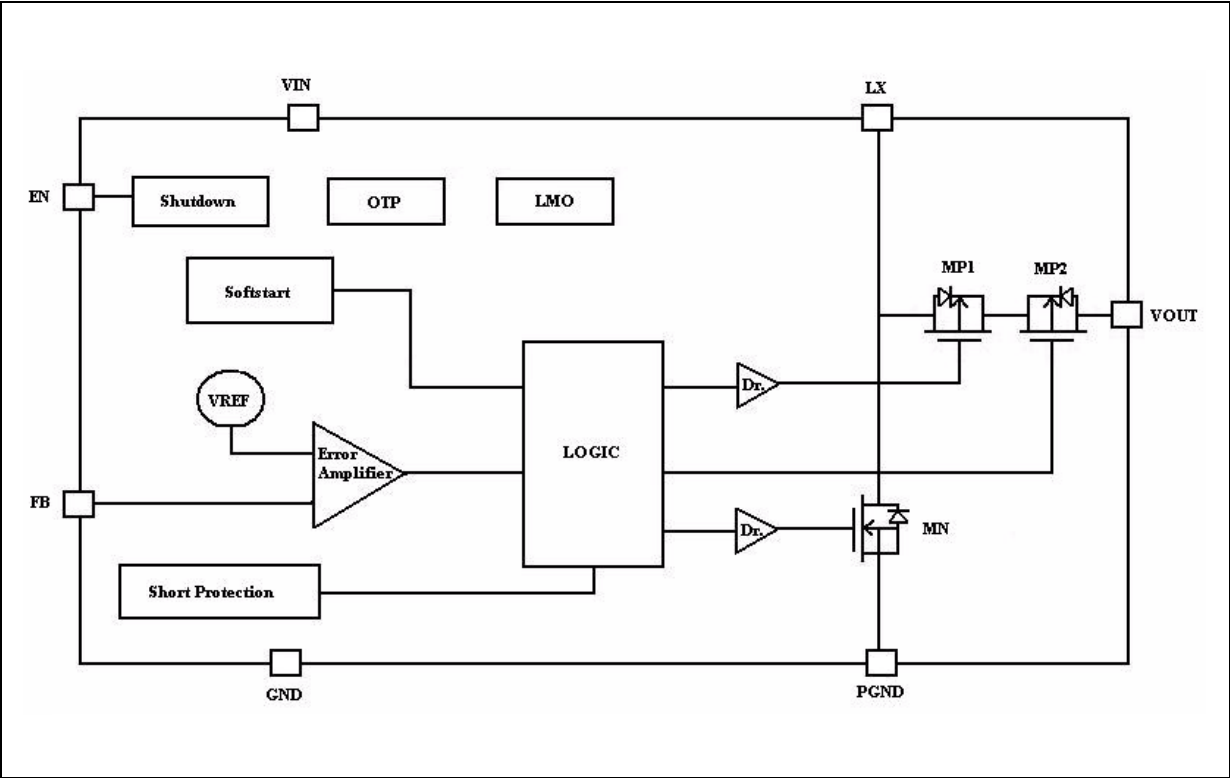
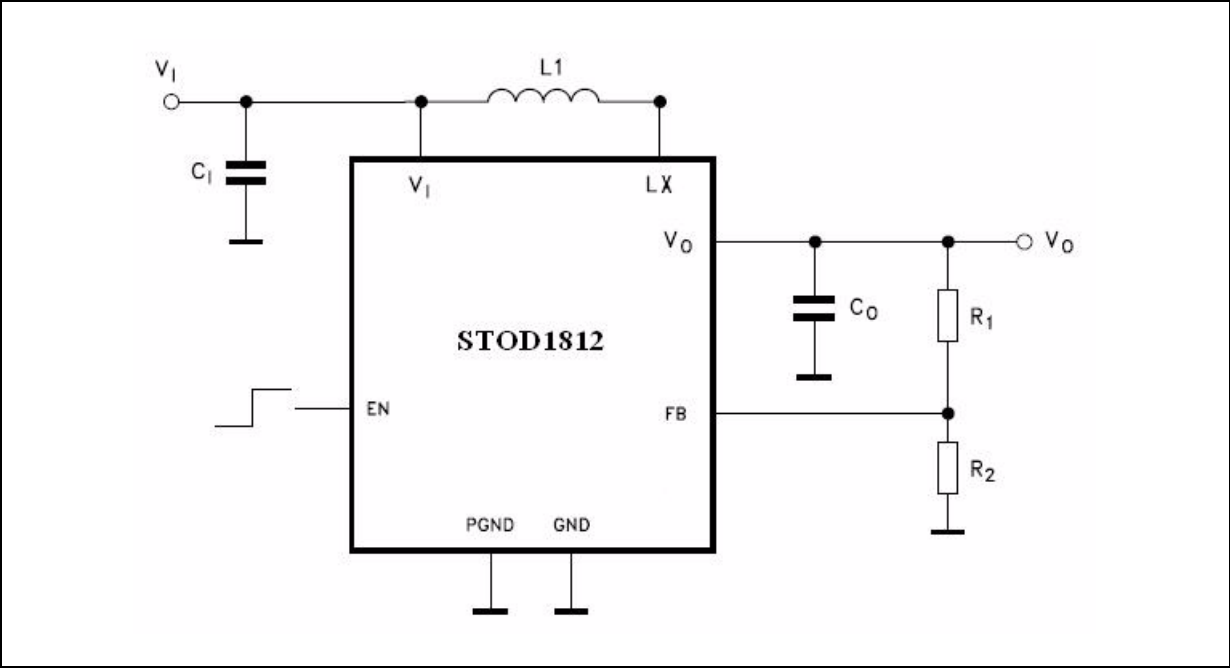


Figure 2. Schematic diagram



2 Pin configuration

Figure 3. Pin connections (top view)

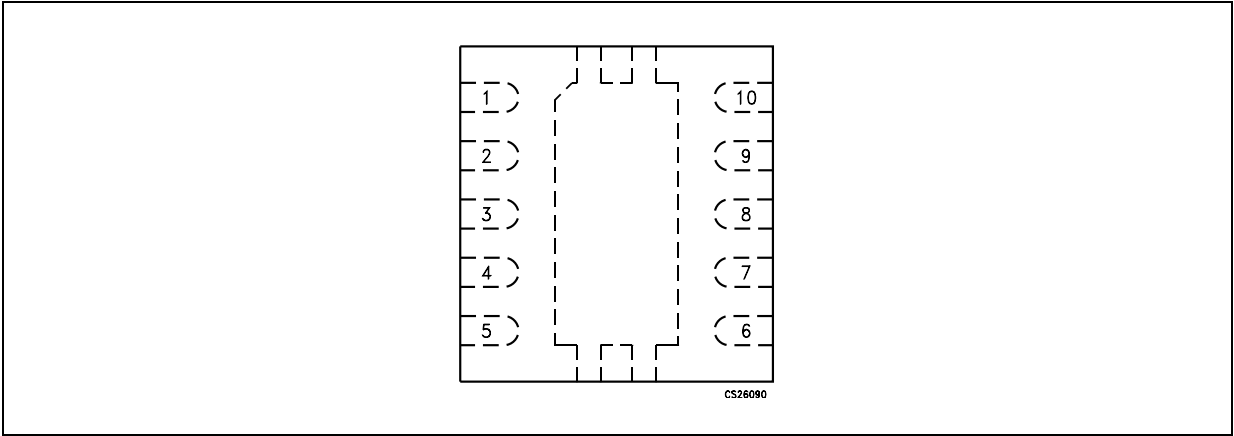


Table 2. Pin description

Pin n°	Symbol	Description
1	OUT	Output voltage
2	OUT	Output voltage
3	GND	Ground
4	FB	Feedback
5	EN	DC supply voltage enable control pin. ON = V_I . When pulled low put the device in shutdown mode.
6	V_I	Input supply voltage.
7	L_X	Switching node
8	L_X	Switching node
9	PGND	Power ground
10	PGND	Power ground
	Exp Pad	Exposed Pad. It must be connected to power ground

3 Maximum ratings

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_I	DC supply voltage	-0.3 to 6	V
EN	Enable pin	-0.3 to 6	V
FB	Feedback pin	-0.3 to 6	V
L_X	Switching node	-0.3 to 20	V
I_{LX}	Switching current	Internally limited	A
V_{OUT}	Converter output voltage	-0.3 to 20	V
P_D	Power dissipation	Internally limited	mW
T_{STG}	Storage temperature range	-65 to 150	°C
T_J	Operating temperature range	-40 to 125	°C

Table 4. Thermal data

Symbol	Parameter	Value	Unit
R_{thJA}	Thermal resistance junction-ambient (tested on 2 layers board)	30.9	°C/W

Table 5. ESD data

Symbol	Parameter	Value	Unit
ESD	Human Body Model	2	kV

4 Electrical characteristics

Table 6. Electrical characteristics

($T_J = -40\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$, $V_I = 3.6\text{ V}$, $C_I = C_O = 4.7\text{ }\mu\text{F}$, $L = 2.2\text{ }\mu\text{H}$, $I_O = 80\text{ mA}$, $V_{EN} = V_I$, $V_O = 18\text{ V}$, $R_1 = 270\text{ k}\Omega$, $R_2 = 20\text{ k}\Omega$ unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
Supply section						
V _I	Supply input voltage	I _O =0 to 120mA	2.5		5.5	V
I _O	Load current	V _I =2.5V to 5.5V	120			mA
UVLO_H	Under voltage lockout HIGH			2.3	2.4	V
UVLO_L	Under voltage lockout LOW		2.1	2.2		V
I _Q	Quiescent current	I _O =120mA		1.3		mA
		No Load, Switching		0.3		mA
		V _{FB} =V _I - No Load, No Switching		35	50	μA
		V _{EN} =GND		100	300	nA
V _{EN} H	Enable high threshold	V _I =2.5V to 5.5V	1.2			V
V _{EN} L	Enable low threshold	V _I =2.5V to 5.5V			0.4	V
I _{EN}	Enable input current	V _{EN} =V _i			500	nA
Dynamic performance						
T _{ON} MAX	T _{ON} max time			0.5		μs
T _{SS}	Soft-start time	From enable to output regulation		0.6		ms
D _{MAX}	Maximum duty cycle			95		%
v	Efficiency	I _O =5 to 30mA		75		%
		I _O =30 to 120mA		85		%
Step-up converter section						
V _{FB1}	Feedback voltage	V _I =2.5V to 5.5V	1.18	1.21	1.24	V
I _{FB}	Feedback leakage current	V _I =2.5V to 5.5V		30	100	nA
V _O _MAX	Output voltage range	V _I =2.5V to 5.5V; I _O =0 to 120mA	18			V
ΔV _O _SLI	Static line regulation	V _I =2.5V to 5.5V, I _{O1} =120mA,		0.6		%/V
ΔV _O _SLO	Static load regulation	I _O =0 to 120mA, V _I =3.6V;		0.0016		%/mA
ΔV _O _LIT	Line transient regulation	V _I =2.5V to 3.0V, I _{O1} =120mA, T _R =T _F =50μs T _A =25°C		80		mV
ΔV _O _LOT	Load transient regulation	I _O =5 to 120mA and I _O =120 to 5mA, T _R =T _F =10μs T _A =25°C, peak to peak		250		mV

Table 6. Electrical characteristics (continued)

($T_J = -40\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$, $V_I = 3.6\text{ V}$, $C_I = C_O = 4.7\text{ }\mu\text{F}$, $L = 2.2\text{ }\mu\text{H}$, $I_O = 80\text{ mA}$, $V_{EN} = V_I$, $V_O = 18\text{ V}$, $R_1 = 270\text{ k}\Omega$, $R_2 = 20\text{ k}\Omega$ unless otherwise specified).

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
SVR	Supply voltage rejection	$I_O = 5$ to 120 mA at 200 Hz -Pulse $0.5V_{PP}$ TDMA noise standard, $T_A = 25^{\circ}\text{C}$ see Figure 14		40		mV
I_{PK}	Inductor peak current	$T_A = 25^{\circ}\text{C}$		2.4		A
$R_{DS(on)P}$	Resistance on P-channel			0.60	0.80	Ω
$R_{DS(on)N}$	Resistance on N-channel			0.25	0.65	Ω
Thermal shutdown						
OTP	Over temperature protection			150		$^{\circ}\text{C}$
OTP_{HYST}	Over temperature protection hysteresis			20		$^{\circ}\text{C}$

5 Functional description

5.1 Boost controller

STOD1812 is a boost converter operating in PFM (pulsed frequency modulation) mode. The converter monitors the output voltage through the bridge resistor divider R_1 and R_2 , and when the feedback voltage falls below the feedback voltage, the boost switch t_{SW} turns on and the inductor current ramps up. The inductor current is measured by detecting the temperature compensated drain voltage of the boost MOSFET. The boost turns off when its drain voltage reaches the internal reference, the main switch remains off until the minimum off time has passed and the feedback voltage is below the reference again. A maximum ON time prevents the switch t_{SW} from staying ON for an excessively long period.

In order to calculate the values of the bridge resistors with a fixed V_O , the following formula can be used:

$$\frac{V_O}{1,21} - 1 = \frac{R_1}{R_2}$$

5.2 Enable

The ENABLE pin is a logic input signal that turns on the controller when the voltage on this pin is equal to or higher than 1.2 V. When the voltage is at or below 0.4 V the STOD1812 goes into shutdown mode. In this case, the true-shutdown switch is turned off and the overall power consumption is reduced to 0.1 μ A. No pull-up or pull-down is present on this pin.

5.3 Efficiency

The total consumption of some PMOLED displays can be as low as 1 mA. In order to increase the battery life of the device, the STOD1812 offers high efficiency over a wide range of output load current and input voltages. See typical application efficiency performance in [Section 8 on page 11](#).

5.4 Under voltage lockout (UVLO)

The minimum supply voltage is 2.5 V, under which the undervoltage lockout circuit operates with a typical threshold of 2.3 V.

6 Typical application information

Figure 4. Typical application circuit connections

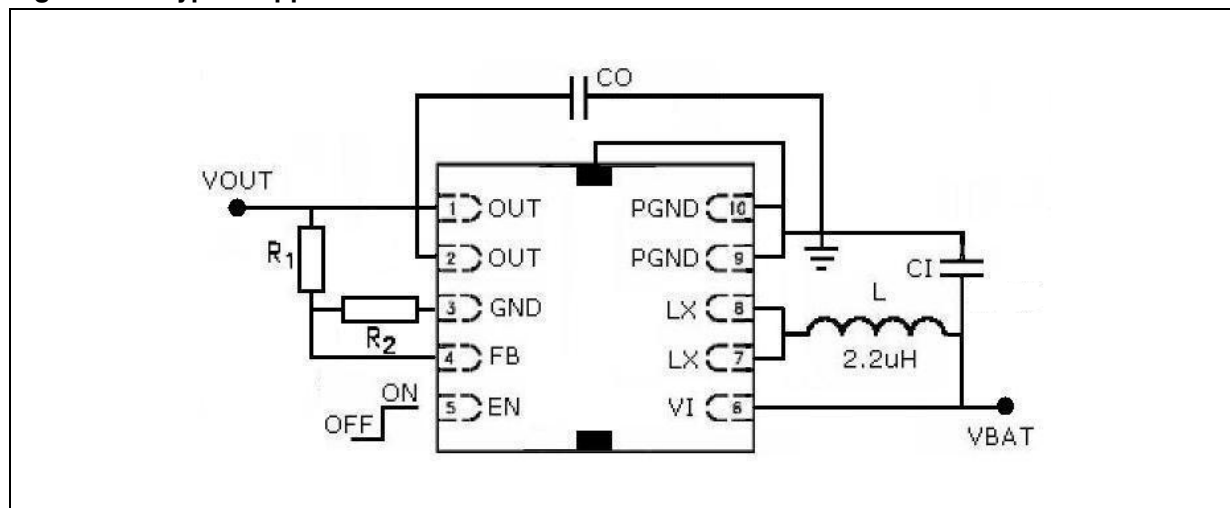


Table 7. External components

Symbol	Parameter	Min.	Typ.	Max.	Unit
L	Inductor ($I_{SAT} = 2.5\text{ A}$)		2.2		μH
C_I	Ceramic capacitor SMD		4.7		μF
C_O	Ceramic capacitor SMD		4.7		μF
R1	Feedback resistor (for $V_O = 18\text{ V}$)		270		$\text{k}\Omega$
R2	Feedback resistor (for $V_O = 18\text{ V}$)		20		$\text{k}\Omega$

Note: The external components suggested in this document should be considered as a design reference guide. The performance data mentioned in the electrical characteristics table are not guaranteed for all the possible electrical parameters of the components included in this list. However, the operation of STOD1812 is not limited to the use of components included in this list.

7 Demonstration board

Figure 5. Demonstration board photo

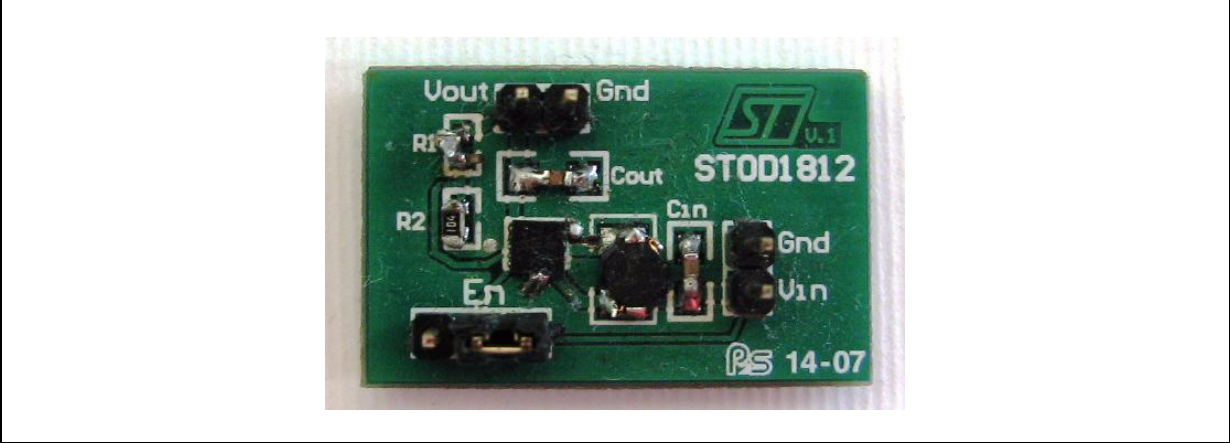


Figure 6. Suggested demonstration board schematic (top layer view)

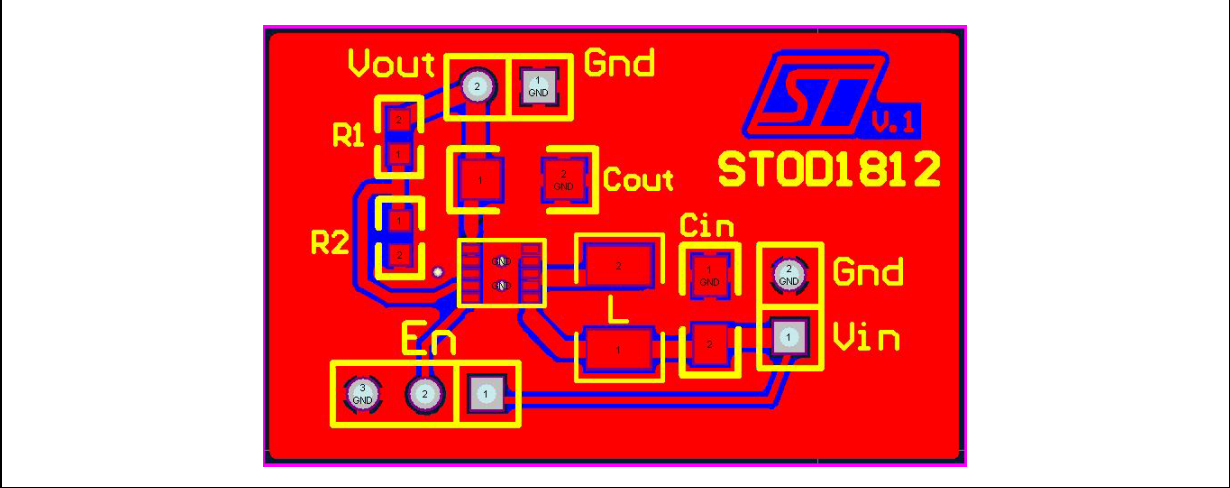
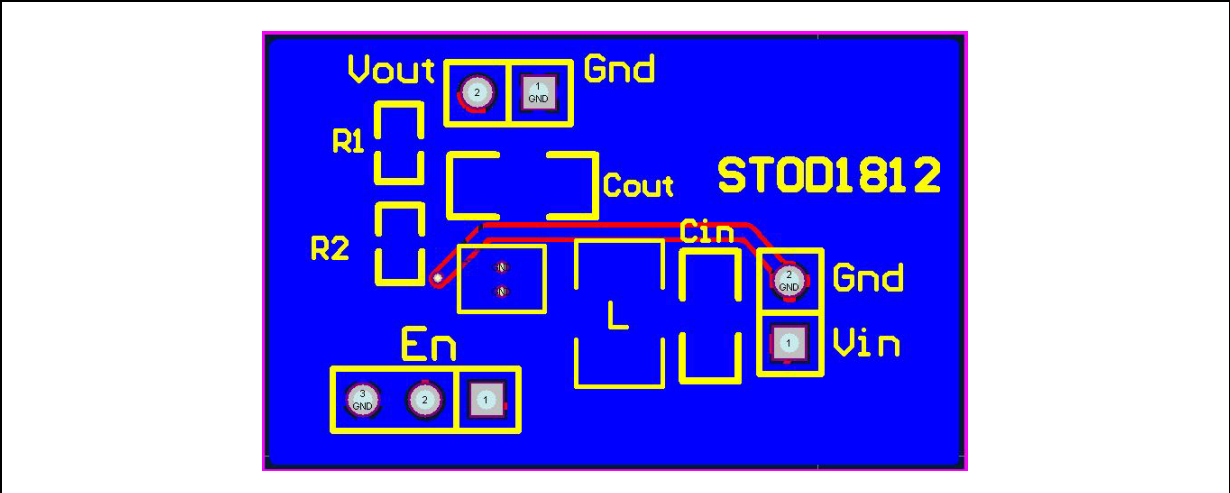


Figure 7. Suggested demonstration board schematic (bottom layer view)



8 Typical application performance

($V_O = 18\text{ V}$, $L = 2.2\text{ }\mu\text{H}$, $C_I = C_O = 4.7\text{ }\mu\text{F}$, $R_1 = 270\text{ k}\Omega$, $R_2 = 20\text{ k}\Omega$)

Figure 8. Efficiency vs output current

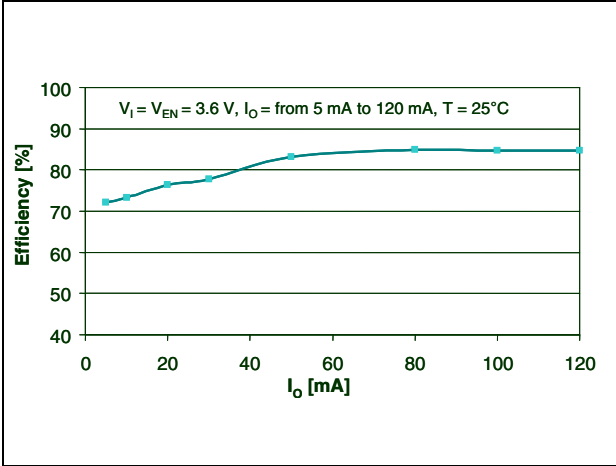


Figure 9. Efficiency vs input voltage

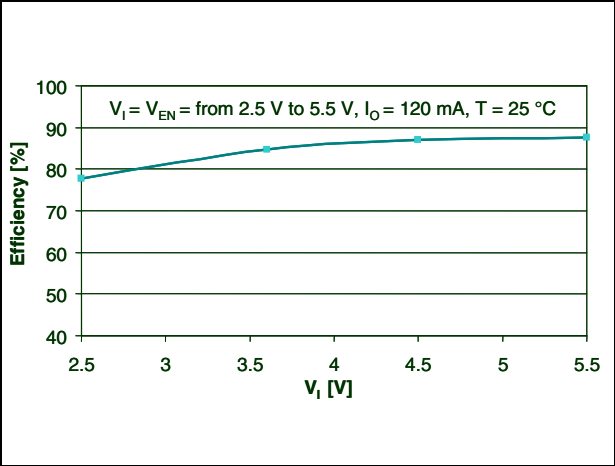


Figure 10. Efficiency vs temperature

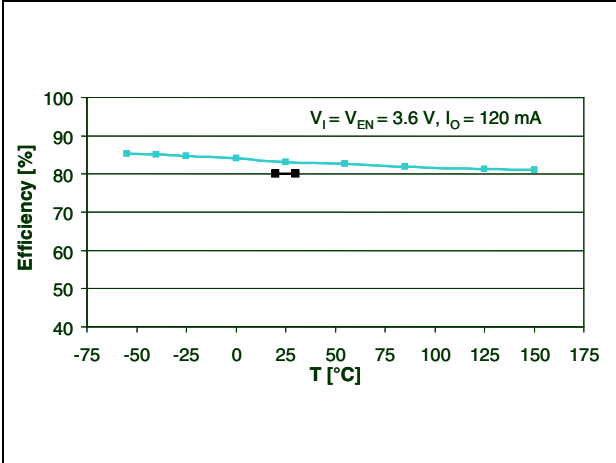


Figure 11. Frequency vs temperature

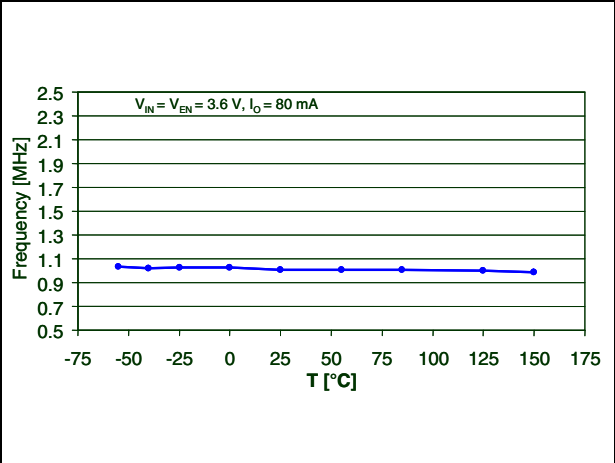


Figure 12. Line transient

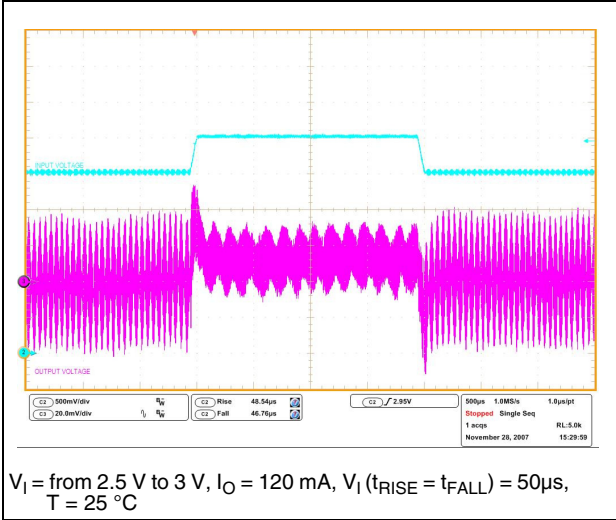


Figure 13. Load transient response

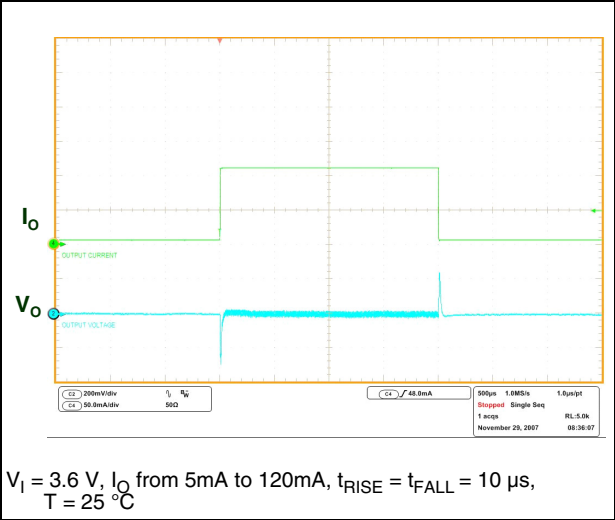
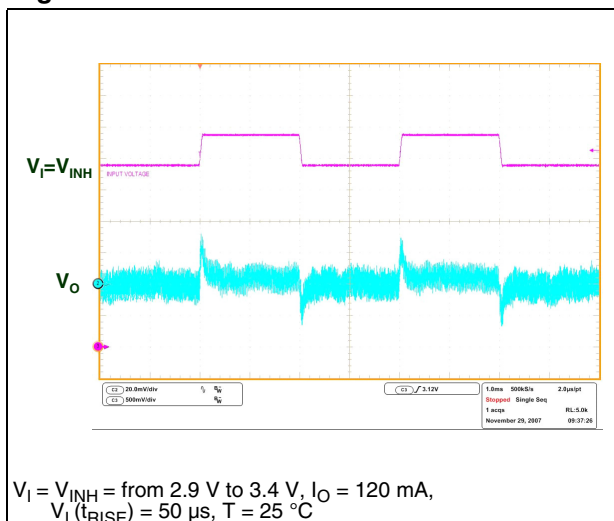


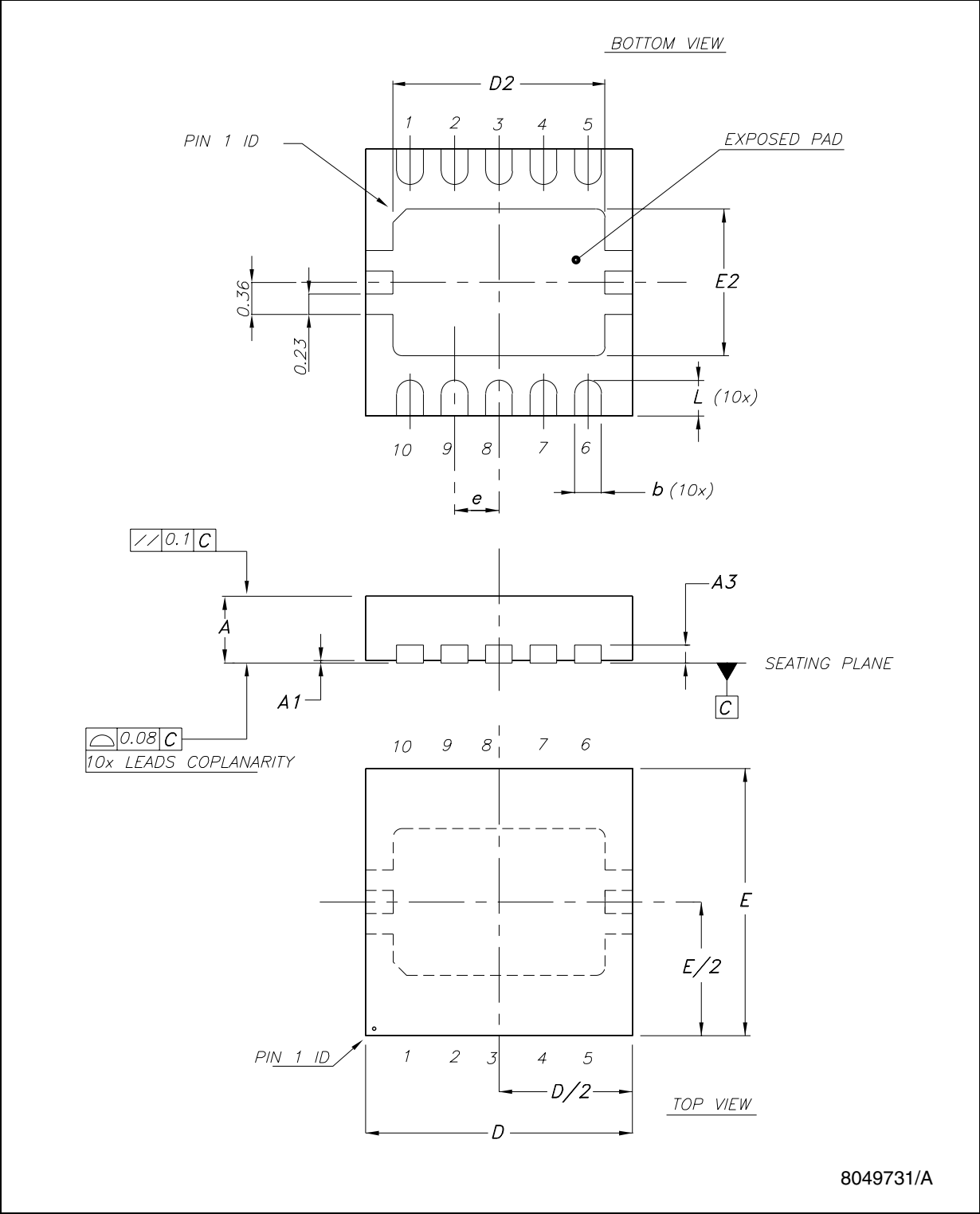
Figure 14. TDMA noise



9 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Figure 15. DFN10L package outline



8049731/A

Table 8. DFN10L mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.70	0.75	0.80	0.028	0.030	0.031
A1	0	0.02	0.05	0	0.001	0.002
A3		0.20			0.008	
b	0.18	0.25	0.30	0.007	0.010	0.012
D	2.90	3	3.10	0.114	0.118	0.122
D2	2.23	2.38	2.48	0.088	0.094	0.098
E	2.90	3	3.10	0.114	0.118	0.122
E2	1.49	1.64	1.74	0.059	0.065	0.069
e		0.50			0.020	
L	0.30	0.40	0.50	0.012	0.016	0.020

Tape & reel QFNxx/DFNxx (3x3) mechanical data

Dim.	mm.			inch.		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			180			7.087
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
T			14.4			0.567
Ao		3.3			0.130	
Bo		3.3			0.130	
Ko		1.1			0.043	
Po		4			0.157	
P		8			0.315	

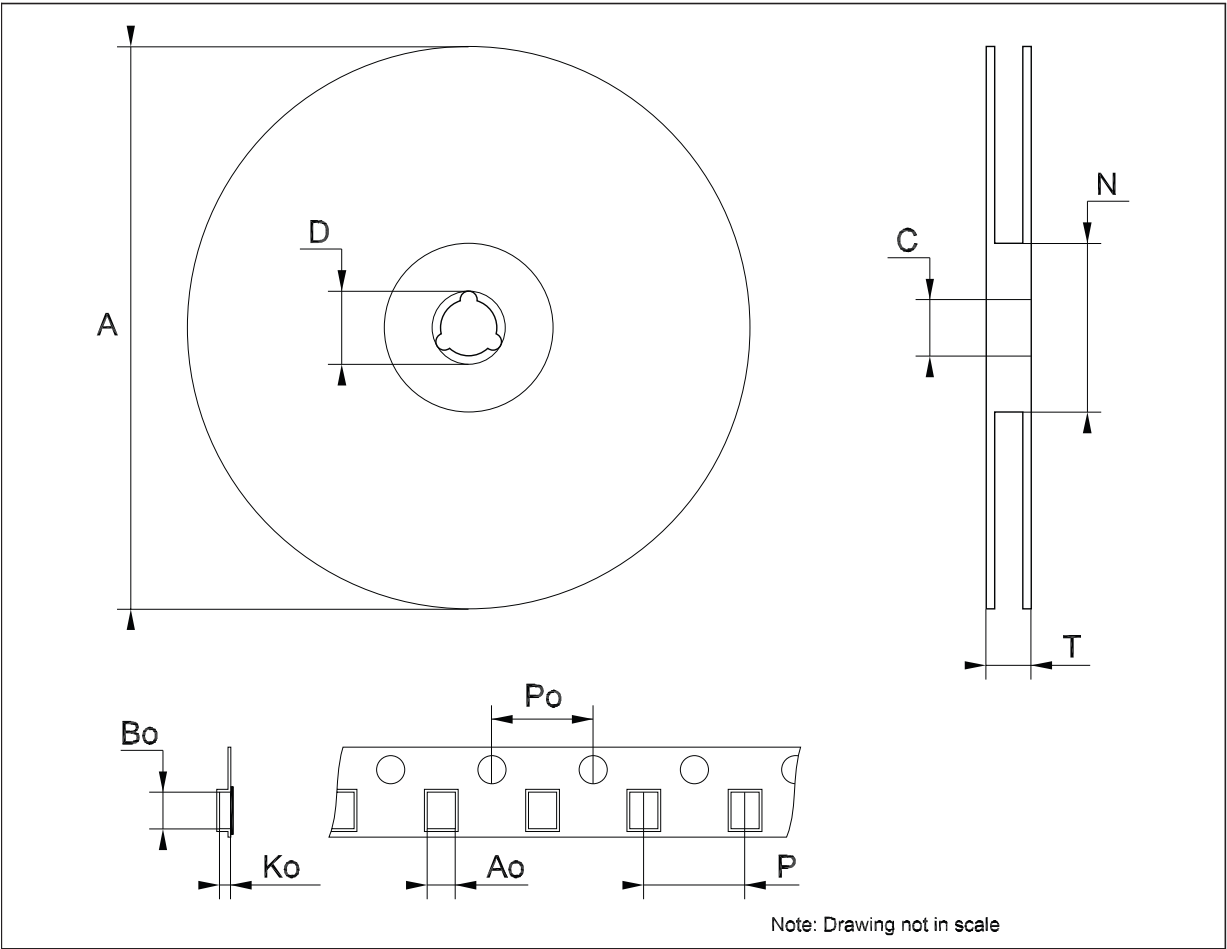
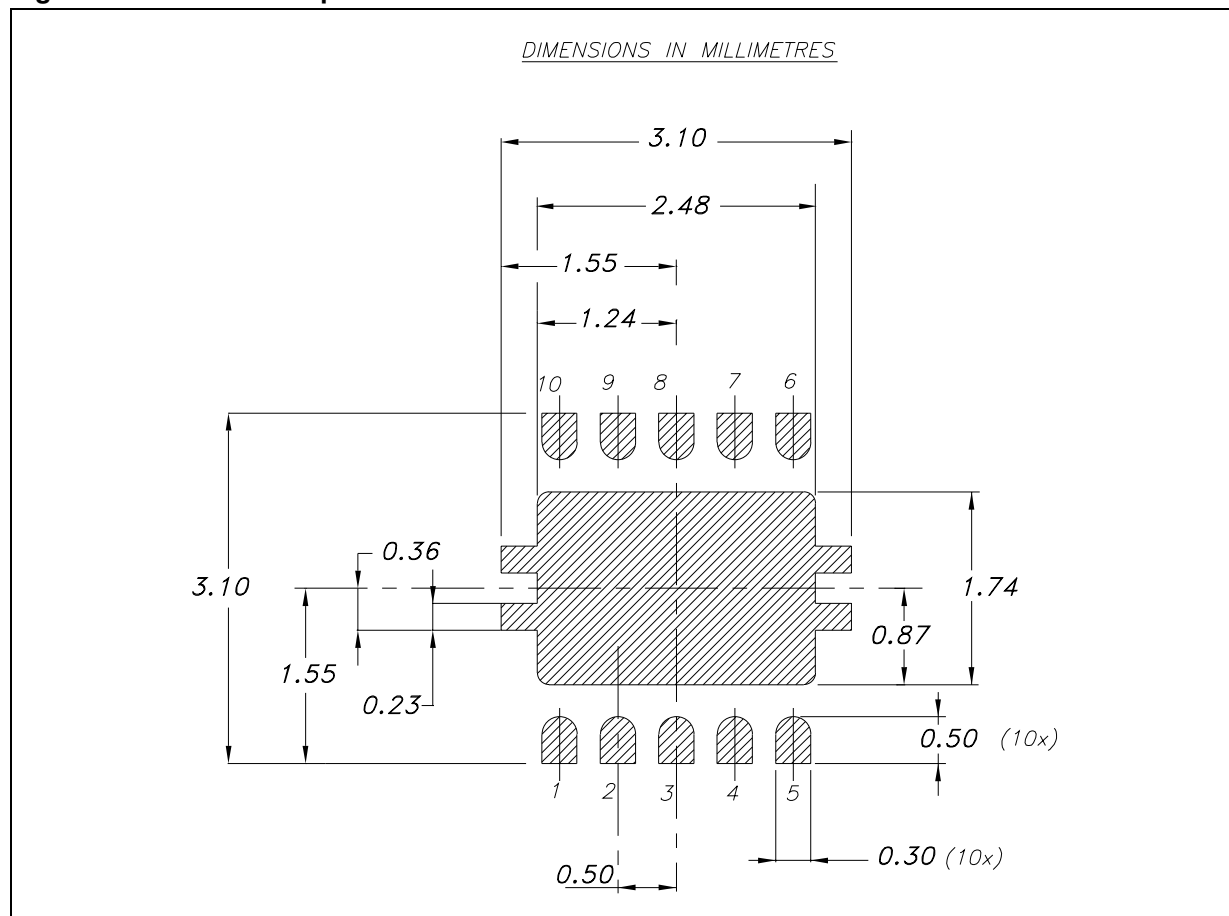


Figure 16. DFN10L footprint - recommended data



10 Revision history

Table 9. Document revision history

Date	Revision	Changes
25-Mar-2008	1	Initial release.

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